3GPP TSG-RAN WG2 Meeting #121-bis electronic R2-2xxxxxx

April 17-26, 2023

Agenda: 8.8

Source: Session Chair (Intel)

Title: Report from IDC breakout session

Document for: Approval

 **Organizational:**

* [AT121bis-e][650][IDC] Organizational Yi – IDC (Intel)

 Scope:

* Share plans for the e-meetings and list/status of ongoing email discussions for the sessions.
* Share meeting notes and agreements for review and endorsement.

 Intended outcome: Endorse running CRs TS38.300 R2-2304107, TS 37.340 R2-2303884, TS38.331 R2-2303353, capability CRs R2-2302979 and R2-2302980 from post-meeting [651], [652], [653] and [654]

 Deadline:

 Company comments by Wednesday 2023-04-19 12:00 pm UTC

## 7.10 IDC enhancements for NR and MR-DC

(NR\_IDC\_enh-Core; leading WG: RAN2; REL-18; WID: RP-221281)

Time budget: 0 TU

Tdoc Limitation: 0 tdocs

Endorsement of running CRs is treated (incl related technical discussion), i.e. the outcome of email discussion [Post121][651][IDC] TS 38.300 CR on IDC (Huawei), [Post121][652][IDC] TS 37.340 CR on IDC (ZTE), [Post121][653][IDC] TS 38.331 CRs on IDC (xiaomi), [Post121][654][IDC] Capability CRs on IDC (Intel)

Otherwise this topic is not treated at RAN2 121bis-e.

R2-2302978 [Post121][654][IDC] Capability CRs on IDC (Intel) Intel Corporation discussion Rel-18 NR\_IDC\_enh-Core

* Noted

R2-2302979 38.306 running CR for Rel-18 IDC UE capabilities Intel Corporation draftCR Rel-18 38.306 17.4.0 B NR\_IDC\_enh-Core

* Endorsed

R2-2302980 38.331 running CR for Rel-18 IDC UE capabilities Intel Corporation draftCR Rel-18 38.331 17.4.0 B NR\_IDC\_enh-Core

* Endorsed

R2-2303353 38.331 running CR for introduction of IDC Xiaomi draftCR Rel-18 38.331 17.4.0 NR\_IDC\_enh-Core

* Revised in R2-2304331

R2-2304331 38.331 running CR for introduction of IDC Xiaomi draftCR Rel-18 38.331 17.4.0 NR\_IDC\_enh-Core

* Endorsed

R2-2303884 37.340 Running CR for Introduction of IDC ZTE Corporation, Sanechips draftCR Rel-18 37.340 17.4.0 B NR\_IDC\_enh-Core

* Endorsed

R2-2304107 38.300 running CR for IDC Enhancements Huawei, HiSilicon draftCR Rel-18 38.300 17.4.0 B NR\_IDC\_enh-Core

* Endorsed
* Above CRs to be treated by At-meeting offline discussion [650]